

September 1999 Revised May 2003

NC7SZ19

TinyLogic® UHS 1-of-2 Decoder/Demultiplexer

General Description

The NC7SZ19 is a 1-of-2 decoder with a common output enable. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a broad $\rm V_{CC}$ operating range. The device is specified to operate over the 1.65V to 5.5V $\rm V_{CC}$ operating range. The inputs and outputs are high impedance when $\rm V_{CC}$ is 0V. Inputs tolerate voltages up to 5.5V independent of $\rm V_{CC}$ operating range.

Features

- Space saving SC70 6-lead surface mount package
- Ultra small MicroPak™ leadless package
- Ultra High Speed: t_{PD} 2.7 ns Typ into 50 pF at 5V V_{CC}
- Broad V_{CC} Operating Range; 1.65V to 5.5V
- Power down high impedance inputs/outputs
- Overvoltage tolerant inputs facilitate 5V to 3V translation
- Patented noise/EMI reduction circuitry implemented

Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As		
NC7SZ19P6X	MAA06A	Z19	6-Lead SC70, EIAJ SC88, 1.25mm Wide	3k Units on Tape and Reel		
NC7SZ19L6X	MAC06A	B4	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel		

Pin Descriptions

Pin Names	Description							
Ē	Decoder Output Enable/ Demultiplexer Data							
Α	Decoder Address/Demultiplexer Select							
Y_0, Y_1	Outputs							

Function Table

Inp	out	Output				
Α	Ē	$Y_0 = A + \overline{E}$	$Y_1 = \overline{A} + \overline{E}$			
L	L	L	Н			
Н	L	Н	L			
Χ	Н	Н	Н			

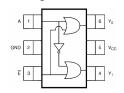
H = HIGH Logic Level

L = LOW Logic Level

X = Don't Care

Connection Diagrams

Pin Assignments for SC70



(Top View)

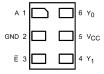
Pin One Orientation Diagram



AAA = Product Code Top Mark - see ordering code

Note: Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

Pad Assignments for MicroPak



(Top Thru View)

 $\label{eq:total_cond} \mbox{TinyLogic@ is a registered trademark of Fairchild Semiconductor Corporation.} \\ \mbox{MicroPak}^{\mbox{\tiny TM}} \mbox{ is a trademark of Fairchild Semiconductor Corporation.} \\$

Absolute Maximum Ratings(Note 1)

-0.5V to +7.0V Supply Voltage (V_{CC}) -0.5V to +7.0V DC Input Voltage (V_{IN}) DC Output Voltage (V_{OUT}) -0.5V to +7.0VDC Input Diode Current (I_{IK}) @ $V_{IN} \le -0.5V$ -50 mA DC Output Diode Current (I_{OK}) @ $V_{IN} \le -0.5V$ -50 mA DC Output Current (I_{OUT}) ±50 mA DC V_{CC} or Ground Current (I_{CC}/I_{GND}) $\pm 100 \; mA$

Storage Temperature Range (T_{STG})
Junction Temperature under Bias (T_{J})
Junction Lead Temperature (T_{L})

 $(\mbox{Soldering, 10 seconds}) \mbox{ 260 °C} \\ \mbox{Power Dissipation ($P_{\rm D}$) @ +85 °C} \mbox{ 180 mW}$

-65°C to +150°C

150°C

Recommended Operating Conditions

Input Rise and Fall Time (t_r, t_f)

 $\begin{array}{lll} & V_{CC} @ \ 1.8V \pm 0.15V, \ 2.5V \pm 0.2V & 0 \ ns/V \ to \ 20 \ ns/V \\ & V_{CC} @ \ 3.3V \pm 0.3V & 0 \ ns/V \ to \ 10 \ ns/V \\ & V_{CC} @ \ 5.0V \pm 0.5V & 0 \ ns/V \ to \ 5 \ ns/V \\ & Thermal \ Resistance \ (\theta_{JA}) & 350^{\circ} C/W \end{array}$

Note 1: Absolute maximum ratings are DC values beyond which the device may be damaged or have its useful life impaired. The datasheet specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation outside datasheet specifications.

DC Electrical Characteristics

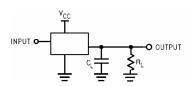
Symbol	Parameter	V _{CC}		T _A = +25°C	;	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	
Symbol	raiametei	(V)	Min	Тур	Max	Min	Max	Units	Conditions	
V _{IH}	HIGH Level	1.65	0.75 V _{CC}			0.75 V _{CC}		V		
	Input Voltage	2.3 – 5.5	0.7 V _{CC}			0.7 V _{CC}		v		
V _{IL}	LOW Level	1.65			0.25 V _{CC}		0.25 V _{CC}	V		
	Input Voltage	2.3 – 5.5			$0.3~\mathrm{V}_{\mathrm{CC}}$		$0.3 V_{CC}$	v		
V _{OH}	HIGH Level	1.65	1.55	1.65		1.55				
	Output Voltage	2.3	2.2	2.3		2.2				$I_{OH} = -100 \mu A$
		3.0	2.9	3.0		2.9				10Η = -100 μΑ
		4.5	4.4	4.5		4.4			$V_{IN} = V_{IH}$	
		1.65	1.29	1.52		1.29		V	or V_{IL}	I _{OH} = -4 mA
		2.3	1.9	2.15		1.9				$I_{OH} = -8 \text{ mA}$
		3.0	2.4	2.80		2.4				$I_{OH} = -16 \text{ mA}$
		3.0	2.3	3.68		2.3				$I_{OH} = -24 \text{ mA}$
		4.5	3.8	4.20		3.8				$I_{OH} = -32 \text{ mA}$
V _{OL}	LOW Level	1.65		0.0	0.10		0.10			
	Output Voltage	2.3		0.0	0.10		0.10			I _{OL} = 100 μA
		3.0		0.0	0.10		0.10		ıc	10L = 100 μΑ
		4.5		0.0	0.10		0.10		$V_{\text{IN}} = V_{\text{IL}}$	
		1.65		0.08	0.24		0.24	V	or V_{IH}	I _{OL} = 4 mA
		2.3		0.10	0.3		0.3			$I_{OL} = 8 \text{ mA}$
		3.0		0.15	0.4		0.4			$I_{OL} = 16 \text{ mA}$
		3.0		0.22	0.55		0.55			$I_{OL} = 24 \text{ mA}$
		4.5		0.22	0.55		0.55			$I_{OL} = 32 \text{ mA}$
I _{IN}	Input Leakage Current	0 to 5.5			±0.1		±1	μΑ	V _{IN} = 5.5V, GND	
I _{OFF}	Power Off Leakage Current	0.0			1		10	μΑ	V _{IN} or V _{OUT} = 5.5V	
I _{CC}	Quiescent Supply Current	1.65 to 5.5			1		10	μΑ	V _{IN} = 5.5V, GND	

AC Electrical Characteristics

Symbol	Parameter	V _{CC}	T _A = +25°C			$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	Figure
		(V)	Min	Тур	Max	Min	Max	Oilles		Number
t _{PLH}	Propagation Delay	1.8 ± 0.15	2.5	5.9	10.5	2.5	11.0			
t _{PHL}	A or E to Output	2.5 ± 0.2	1.2	3.5	6.0	1.2	6.4	ns	$C_L = 15 pF$,	Figures 1, 3
		3.3 ± 0.3	0.8	2.7	4.1	0.8	4.5	115	$R_L=1\ M\Omega$	
		5.0 ± 0.5	0.5	2.1	3.2	0.5	3.5			
t _{PLH}	Propagation Delay	3.3 ± 0.3	1.2	3.2	5.1	1.2	5.4	ns	$C_L = 50 \text{ pF},$	Figures 1, 3
t _{PHL}	A or E to Output	5.0 ± 0.5	0.8	2.7	4.0	0.8	4.3	115	$R_L=500\Omega$	
C _{IN}	Input Capacitance	0		2.3				pF		
C _{PD}	Power Dissipation	3.3		10.5				pF	(Note 2)	Figure 2
	Capacitance	5.0		12.8				pΓ	(Note 2)	Figure 2

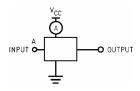
Note 2: C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 2.) C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD} = (C_{PD})(V_{CC})(f_{IN}) + (I_{CC}static).$

AC Loading and Waveforms



C_L includes load and stray capacitance Input PRR = 1.0 MHz; $t_W = 500 \text{ ns}$

FIGURE 1. AC Test Circuit



 $\begin{aligned} & \text{Input} = \text{AC Waveform; } t_r = t_f = 1.8 \text{ ns} \\ & \text{PRR} = 10 \text{ MHz; Duty Cycle} = 50\% \\ & \overline{E} \text{ Input} = \text{GND} \end{aligned}$

FIGURE 2. I_{CCD} Test Circuit

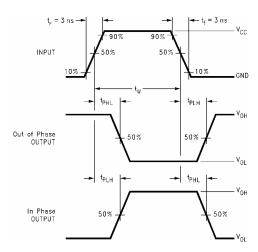


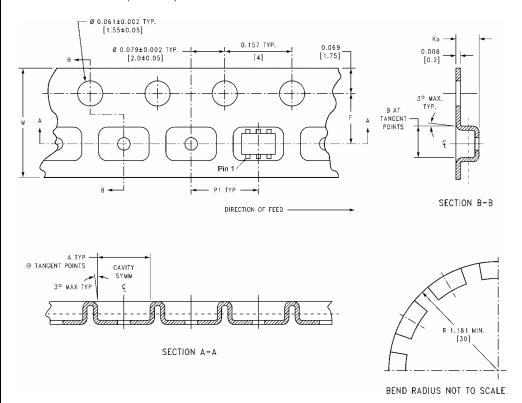
FIGURE 3. AC Waveforms

Tape and Reel Specification

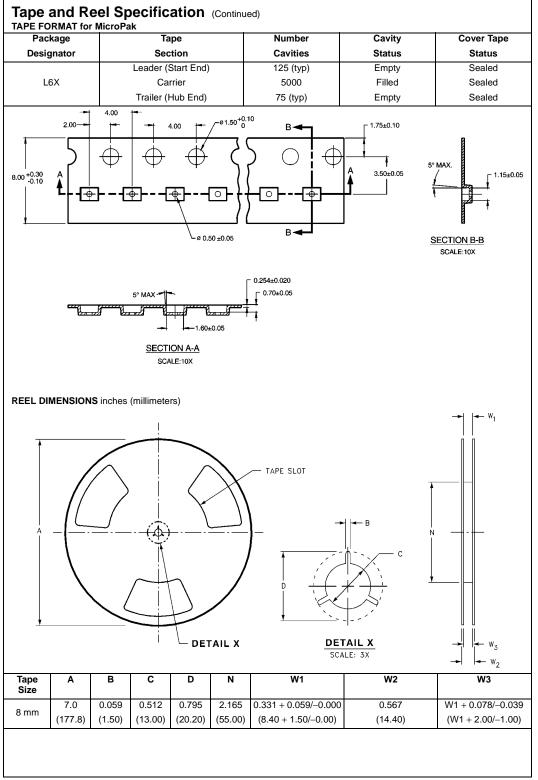
TAPE FORMAT for SC70

Package	Tape	Number	Cavity	Cover Tape	
Designator	Section	Cavities	Status	Status	
	Leader (Start End)	125 (typ)	Empty	Sealed	
P6X	Carrier	3000	Filled	Sealed	
	Trailer (Hub End)	75 (typ)	Empty	Sealed	

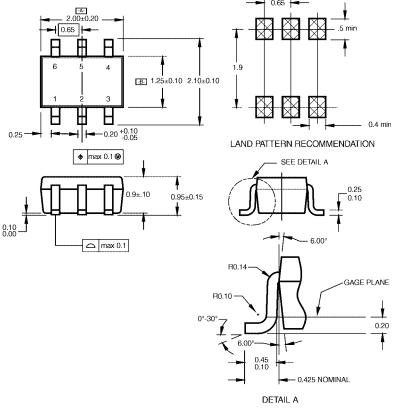
TAPE DIMENSIONS inches (millimeters)



Package	Tape Size	DIM A	DIM B	DIM F	DIM K _o	DIM P1	DIM W
SC70-6	8 mm	0.093	0.096	0.138 ± 0.004	0.053 ± 0.004	0.157	0.315 ± 0.004
	O IIIIII	(2.35)	(2.45)	(3.5 ± 0.10)	(1.35 ± 0.10)	(4)	(8 ± 0.1)



Physical Dimensions inches (millimeters) unless otherwise noted



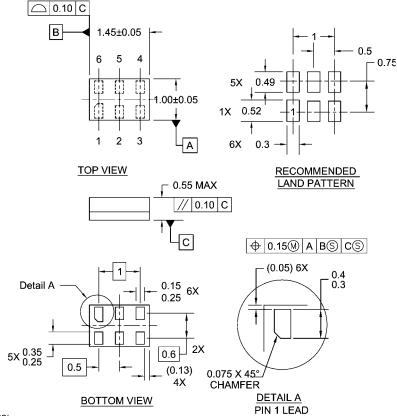
NOTES:

- A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88.
- B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.
- C. DIMENSIONS ARE IN MILLIMETERS.

6-Lead SC70, EIAJ SC88, 1.25mm Wide Package Number MAA06A

MAA06ARevC

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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